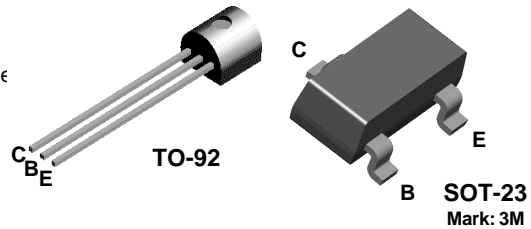


## 2N5210/MMBT5210

### NPN General Purpose Amplifier

This device is designed for low noise, high gain, general purpose amplifier applications at collector currents from 1μA to 50 mA.



### Absolute Maximum Ratings\*

TA = 25°C unless otherwise noted

| Symbol         | Parameter  | Value       | Units |
|----------------|--|-------------|-------|
| $V_{CEO}$      | Collector-Emitter Voltage                        | 50          | V     |
| $V_{CBO}$      | Collector-Base Voltage                           | 50          | V     |
| $V_{EBO}$      | Emitter-Base Voltage                             | 4.5         | V     |
| $I_C$          | Collector Current - Continuous                   | 100         | mA    |
| $T_J, T_{stg}$ | Operating and Storage Junction Temperature Range | -55 to +150 | °C    |

\* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### NOTES:

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### Thermal Characteristics

TA = 25°C unless otherwise noted

| Symbol          | Characteristic                                | Max.       |            | Units       |
|-----------------|---|------------|------------|-------------|
|                 |   | 2N5210     | MMBT5210   |             |
| $P_D$           | Total Device Dissipation<br>Derate above 25°C | 625<br>5.0 | 350<br>2.8 | mW<br>mW/°C |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case          | 83.3       |            | °C/W        |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient       | 200        | 357        | °C/W        |

# NPN General Purpose Amplifier

(continued)

## Electrical Characteristics

$T_A = 25^\circ\text{C}$  unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Max | Units |
|--------|-----------|-----------------|-----|-----|-------|
|--------|-----------|-----------------|-----|-----|-------|

### OFF CHARACTERISTICS

|               |                                     |                                  |    |    |    |
|---------------|-------------------------------------|----------------------------------|----|----|----|
| $V_{(BR)CEO}$ | Collector-Emitter Breakdown Voltage | $I_C = 1.0\text{ mA}, I_B = 0$   | 50 |    | V  |
| $V_{(BR)CBO}$ | Collector-Base Breakdown Voltage    | $I_C = 0.1\text{ mA}, I_E = 0$   | 50 |    | V  |
| $I_{CBO}$     | Collector Cutoff Current            | $V_{CB} = 35\text{ V}, I_E = 0$  |    | 50 | nA |
| $I_{EBO}$     | Emitter Cutoff Current              | $V_{EB} = 3.0\text{ V}, I_C = 0$ |    | 50 | nA |

### ON CHARACTERISTICS

|               |                                      |  |                   |      |   |
|---------------|--------------------------------------|--|-------------------|------|---|
| $h_{FE}$      | DC Current Gain                      | $I_C = 100\text{ }\mu\text{A}, V_{CE} = 5.0\text{ V}$<br>$I_C = 1.0\text{ mA}, V_{CE} = 5.0\text{ V}$<br>$I_C = 10\text{ mA}, V_{CE} = 5.0\text{ V}^*$ | 200<br>250<br>250 | 600  |   |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage | $I_C = 10\text{ mA}, I_B = 1.0\text{ mA}$  |                   | 0.7  | V |
| $V_{BE(on)}$  | Base-Emitter On Voltage              | $I_C = 1.0\text{ mA}, V_{CE} = 5.0\text{ V}$   |                   | 0.85 | V |

### SMALL SIGNAL CHARACTERISTICS

|          |                                  |   |     |            |          |
|----------|----------------------------------|---|-----|------------|----------|
| $f_T$    | Current Gain - Bandwidth Product | $I_C = 500\text{ }\mu\text{A}, V_{CE} = 5.0\text{ V},$<br>$f = 20\text{ MHz}$   | 30  |            | MHz      |
| $C_{cb}$ | Collector-Base Capacitance       | $V_{CB} = 5.0\text{ V}, I_E = 0, f = 100\text{ kHz}$  |     | 4.0        | pF       |
| $h_{fe}$ | Small-Signal Current Gain        | $I_C = 1.0\text{ mA}, V_{CE} = 5.0\text{ V},$<br>$f = 1.0\text{ kHz}$   | 250 | 900        |          |
| NF       | Noise Figure                     | $I_C = 20\text{ }\mu\text{A}, V_{CE} = 5.0\text{ V},$<br>$R_S = 22\text{ k}\Omega, f = 10\text{ Hz to }15.7\text{ kHz}$<br>$I_C = 20\text{ }\mu\text{A}, V_{CE} = 5.0\text{ V},$<br>$R_S = 10\text{ k}\Omega, f = 1.0\text{ kHz}$ |     | 2.0<br>3.0 | dB<br>dB |

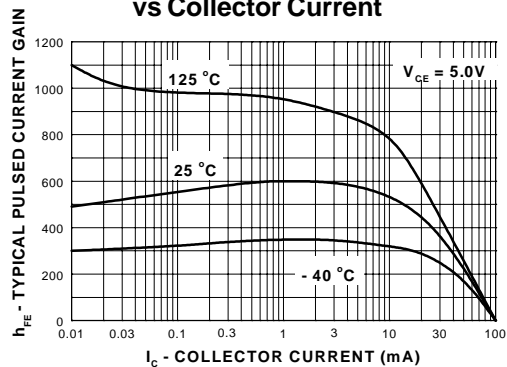
\*Pulse Test: Pulse Width  $\leq 300\text{ }\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

# NPN General Purpose Amplifier

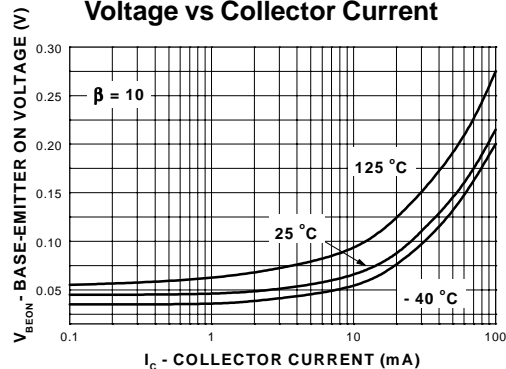
(continued)

## Typical Characteristics

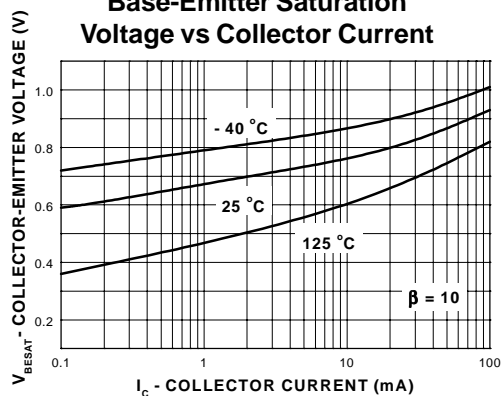
**Typical Pulsed Current Gain vs Collector Current**



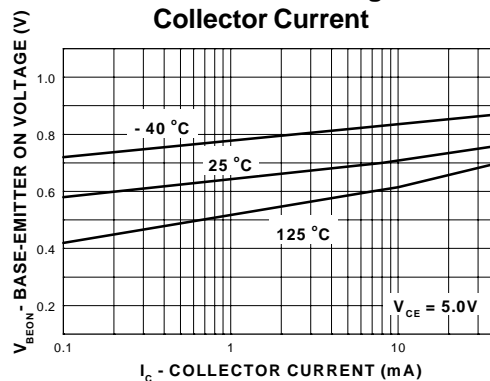
**Collector-Emitter Saturation Voltage vs Collector Current**



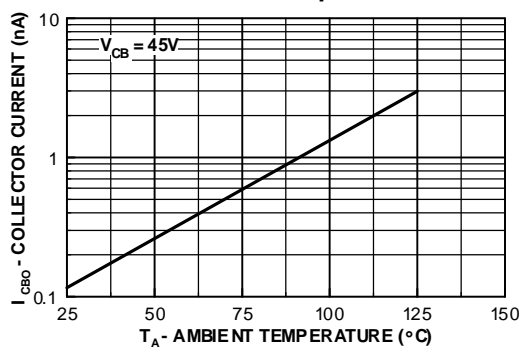
**Base-Emitter Saturation Voltage vs Collector Current**



**Base-Emitter ON Voltage vs Collector Current**



**Collector-Cutoff Current vs Ambient Temperature**

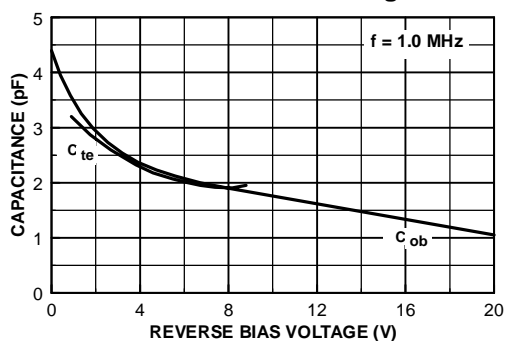


# NPN General Purpose Amplifier

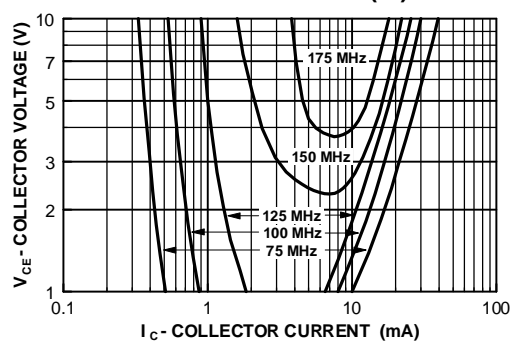
(continued)

## Typical Characteristics (continued)

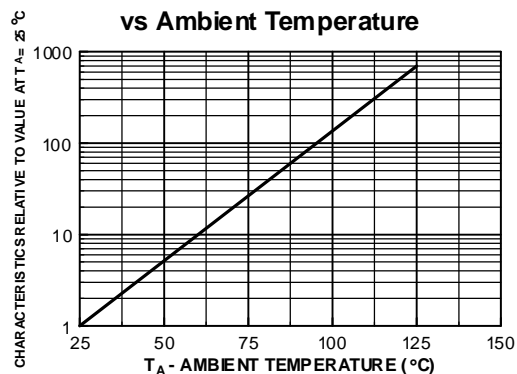
Input and Output Capacitance  
vs Reverse Bias Voltage



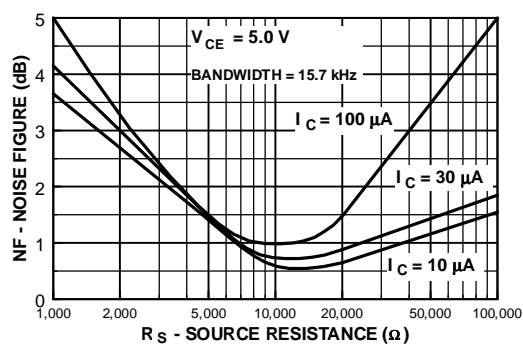
Contours of Constant Gain  
Bandwidth Product ( $f_T$ )



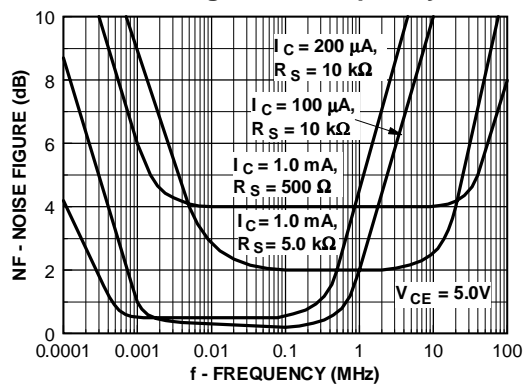
Normalized Collector-Cutoff Current  
vs Ambient Temperature



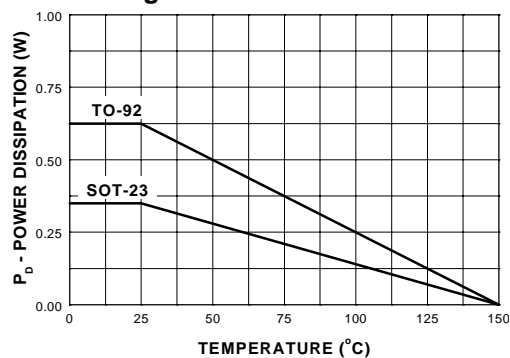
Wideband Noise Frequency  
vs Source Resistance



Noise Figure vs Frequency



Base-Emitter Saturation  
Voltage vs Collector Current

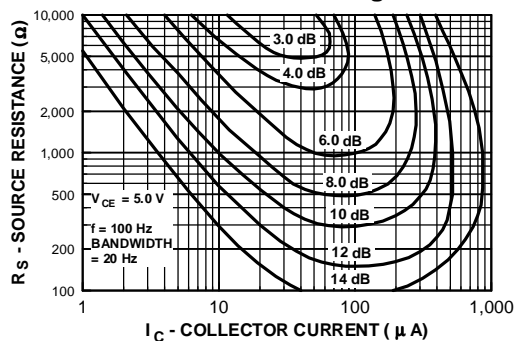


# NPN General Purpose Amplifier

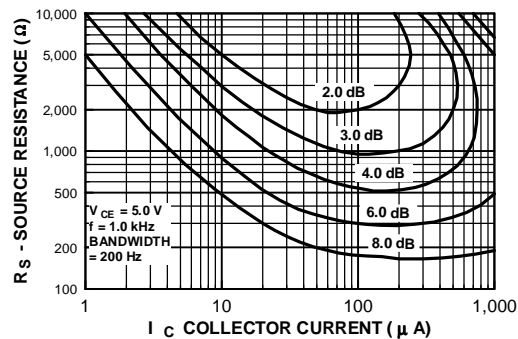
(continued)

## Typical Characteristics (continued)

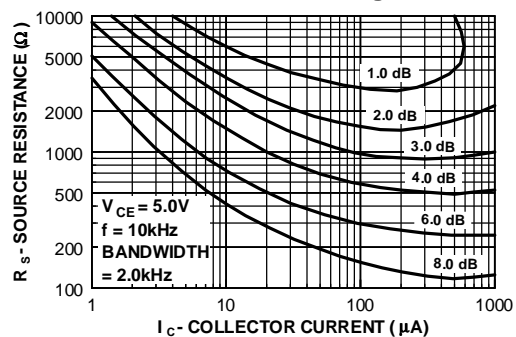
Contours of Constant  
Narrow Band Noise Figure



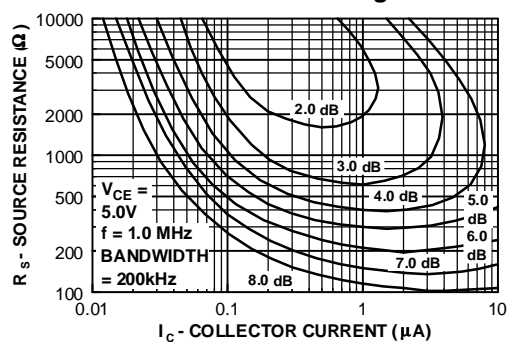
Contours of Constant  
Narrow Band Noise Figure



Contours of Constant  
Narrow Band Noise Figure



Contours of Constant  
Narrow Band Noise Figure

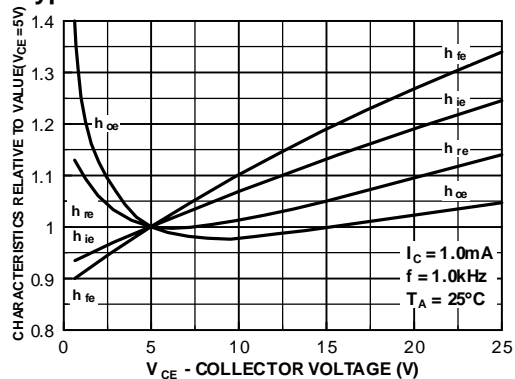


# NPN General Purpose Amplifier

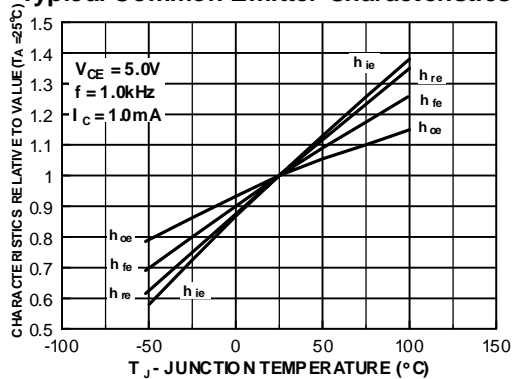
(continued)

## Typical Common Emitter Characteristics (f = 1.0 kHz)

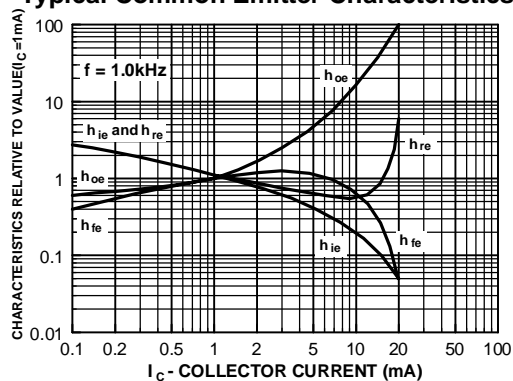
Typical Common Emitter Characteristics



Typical Common Emitter Characteristics



Typical Common Emitter Characteristics



## TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

|                      |                     |                     |                 |      |
|----------------------|---------------------|---------------------|-----------------|------|
| ACEx™                | FAST®               | OPTOLOGIC™          | SMART START™    | VCX™ |
| Bottomless™          | FASTr™              | OPTOPLANAR™         | STAR*POWER™     |      |
| CoolFET™             | FRFET™              | PACMAN™             | Stealth™        |      |
| CROSSVOLT™           | GlobalOptoisolator™ | POP™                | SuperSOT™-3     |      |
| DenseTrench™         | GTO™                | Power247™           | SuperSOT™-6     |      |
| DOMETM               | HiSeC™              | PowerTrench®        | SuperSOT™-8     |      |
| EcoSPARK™            | ISOPLANAR™          | QFET™               | SyncFET™        |      |
| E <sup>2</sup> CMOS™ | LittleFET™          | QST™                | TinyLogic™      |      |
| EnSigna™             | MicroFET™           | QT Optoelectronics™ | TruTranslation™ |      |
| FACT™                | MicroPak™           | Quiet Series™       | UHC™            |      |
| FACT Quiet Series™   | MICROWIRE™          | SILENT SWITCHER®    | UltraFET®       |      |

STAR\*POWER is used under license

## DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

## LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## PRODUCT STATUS DEFINITIONS

### Definition of Terms

| Datasheet Identification | Product Status         | Definition  |
|--------------------------|------------------------|---|
| Advance Information      | Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.  |
| Preliminary              | First Production       | This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| No Identification Needed | Full Production        | This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.   |
| Obsolete                 | Not In Production      | This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.   |

Rev. H4